

P-Channel 30-V(D-S) MOSFET

$V_{(BR)DSS}$	$R_{DS(on)MAX}$	I_D
-30V	0.053Ω@-10V	-4.2A
	0.065Ω@-4.5V	
	0.085Ω@-2.5V	

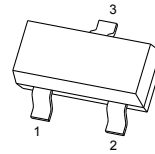
General FEATURE

- TrenchFET Power MOSFET
- Lead free product is acquired
- Surface mount package

APPLICATION

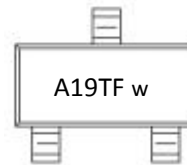
- Load Switch for Portable Devices
- DC/DC Converter

SOT-23-3L



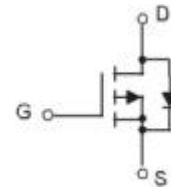
- 1.GATE
- 2.SOURCE
- 3.DRAIN

MARKING



*w: week code

Equivalent Circuit



Maximum ratings ($T_a=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	-30	V
Gate-Source Voltage	V_{GS}	±12	
Continuous Drain Current	I_D	-4.2	A
Pulsed Drain Current	I_{DM}	-30	
Maximum Power Dissipation	P_D	1.25	W
Thermal Resistance from Junction to Ambient($t \leq 5s$)	$R_{\theta JA}$	95	$^{\circ}\text{C/W}$
Junction Temperature	T_J	150	$^{\circ}\text{C}$
Storage Temperature	T_{stg}	-55 ~+150	

MOSFET ELECTRICAL CHARACTERISTICS

T_a =25 °C unless otherwise specified

Parameter	Symbol	Test Condition	Min	Typ	Max	Units
Static characteristics						
Drain-source breakdown voltage	BV _{DSS}	V _{GS} = 0V, I _D =-250μA	-30			V
Zero gate voltage drain current	I _{DSS}	V _{DS} =-24V, V _{GS} = 0V			-1	μA
Gate-source leakage current	I _{GSS}	V _{GS} =±12V, V _{DS} = 0V			±100	nA
Drain-source on-resistance (note a)	R _{DS(on)}	V _{GS} =-10V, I _D =-4.0A		50	53	mΩ
		V _{GS} =-4.5V, I _D =-3.5A		60	65	mΩ
		V _{GS} =-2.5V, I _D =-2.5A		80	85	mΩ
Forward tranconductance (note a)	g _{FS}	V _{DS} =-5V, I _D =-4.2A	7	10		S
Gate threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =-250μA	-0.6	-1	-1.2	V
Diode forward voltage (note a)	V _{SD}	I _S =-1A, V _{GS} =0V			-1.2	V
Dynamic characteristics (note b)						
Input capacitance	C _{iss}	V _{DS} =-15V, V _{GS} = 0 V, f =1MHz		950		pF
Output capacitance	C _{oss}			115		pF
Reverse transfer capacitance	C _{rss}			75		pF
Switching Characteristics (note b)						
Turn-on delay time	t _{d(on)}	V _{GS} =-10V, V _{DS} =-15V, I _D =-4.2A, R _{GEN} =6Ω		7.0		ns
Turn-on rise time	t _r			3.0		ns
Turn-off delay time	t _{d(off)}			30		ns
Turn-off fall time	t _f			12		ns

Notes:

- a.Pulse Test : Pulse Width < 300μs, Duty Cycle ≤2%.
b.These parameters have no way to verify.

Typical Electrical and Thermal Characteristics

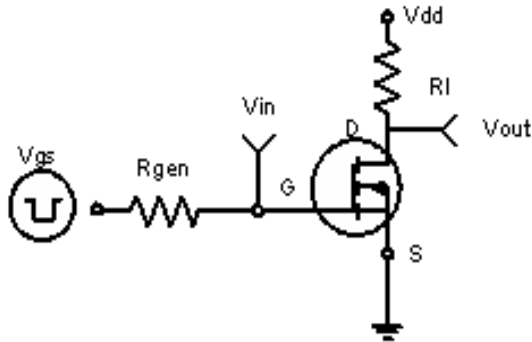


Figure 1: Switching Test Circuit

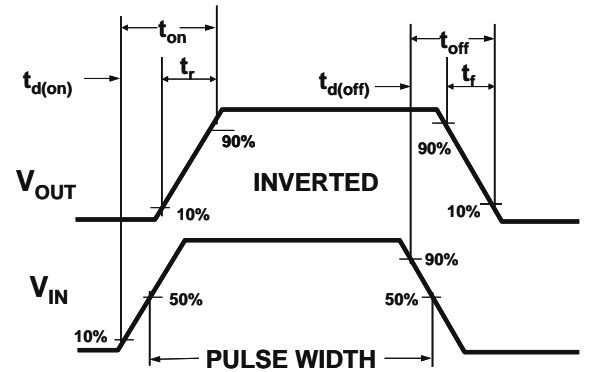


Figure 2: Switching Waveforms

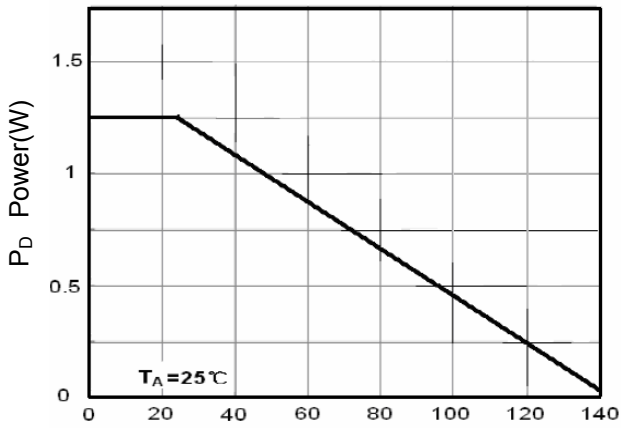


Figure 3 Power Dissipation

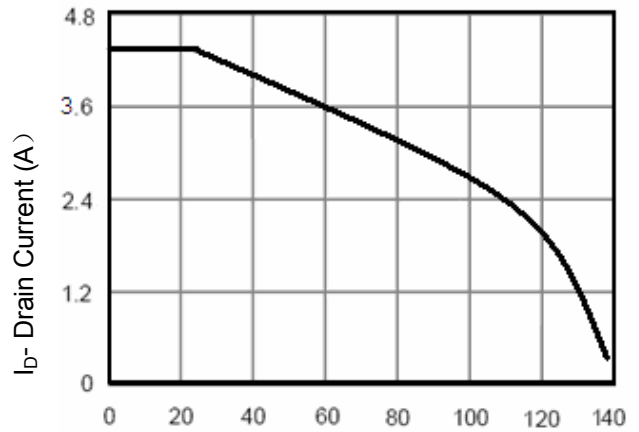


Figure 4 Drain Current

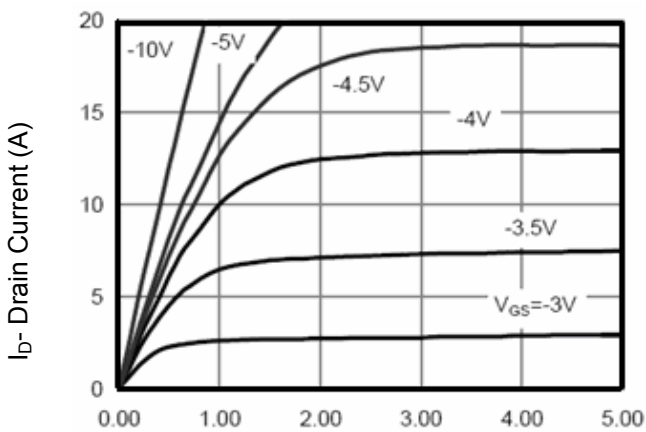


Figure 5 Output Characteristics

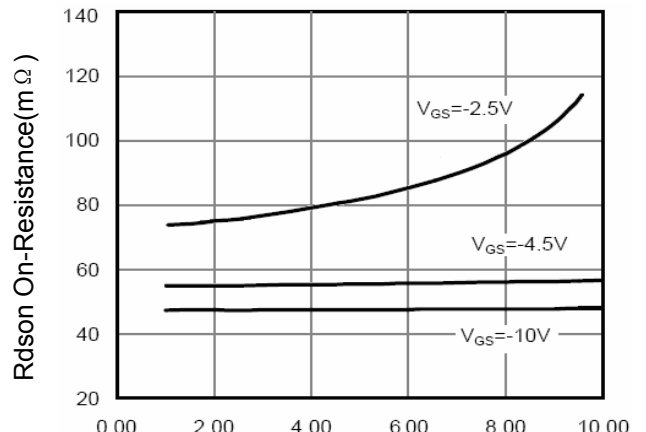


Figure 6 Drain-Source On-Resistance

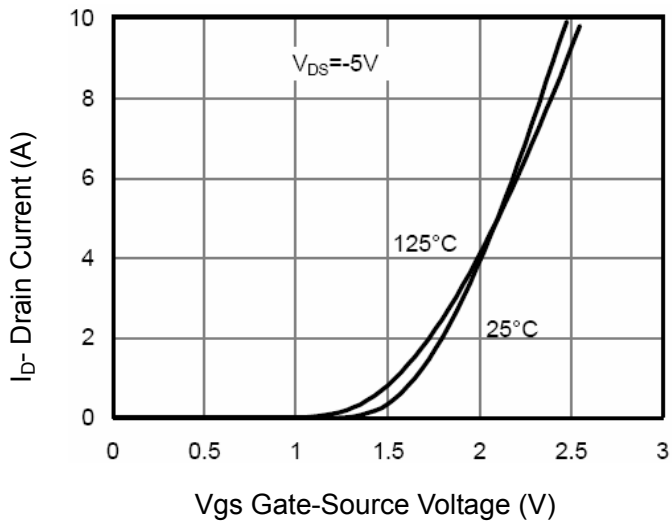


Figure 7 Transfer Characteristics

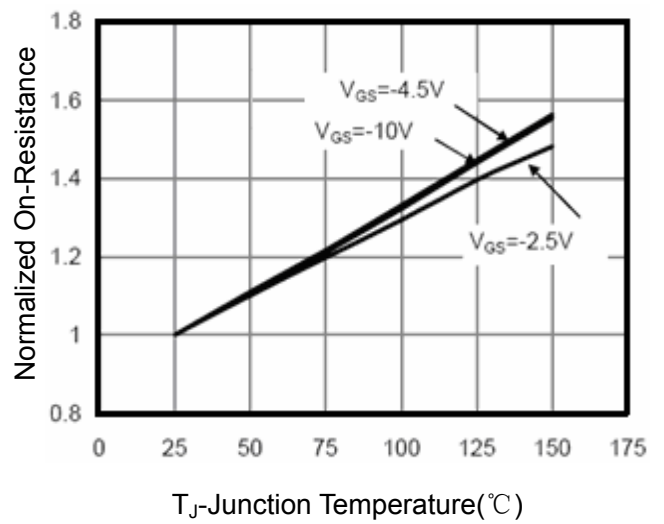


Figure 8 Drain-Source On-Resistance

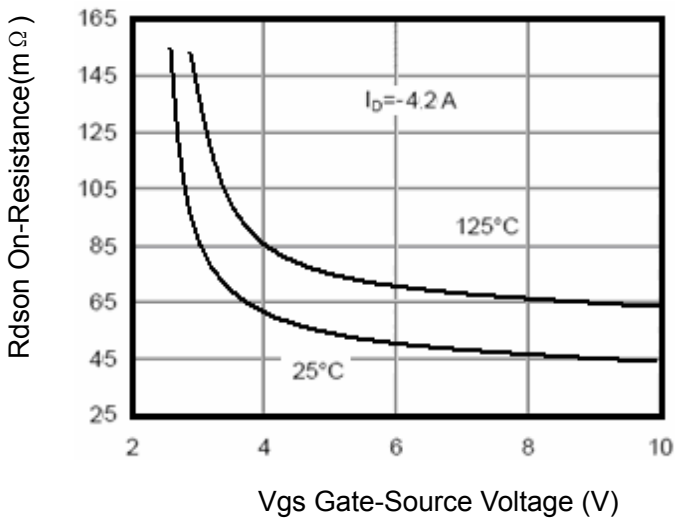


Figure 9 Rdson vs Vgs

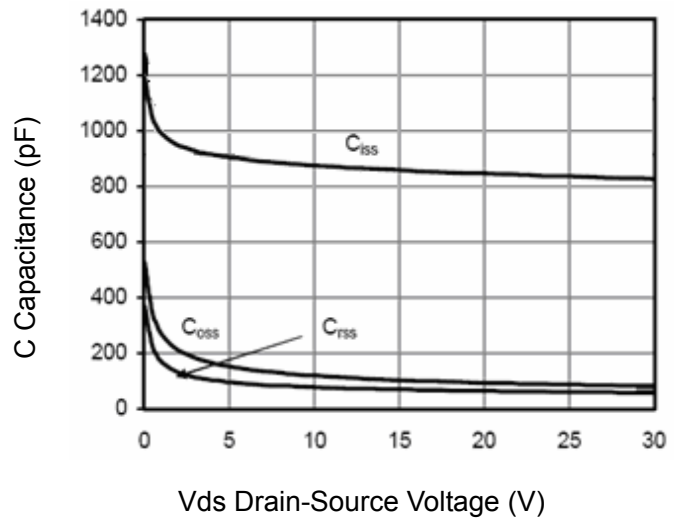


Figure 10 Capacitance vs Vds

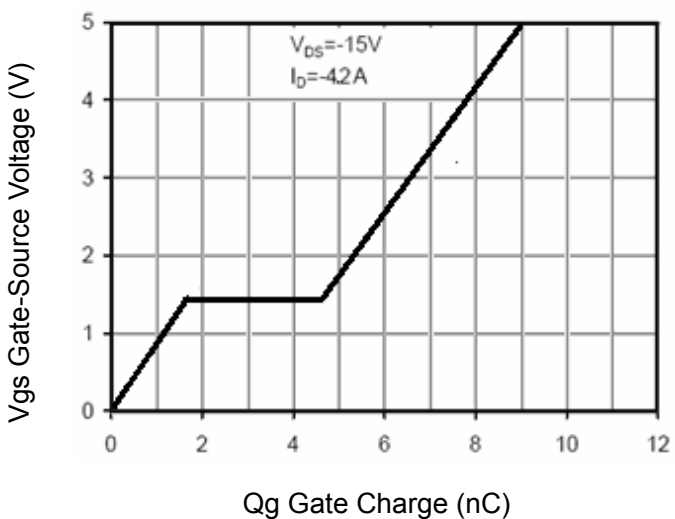


Figure 11 Gate Charge

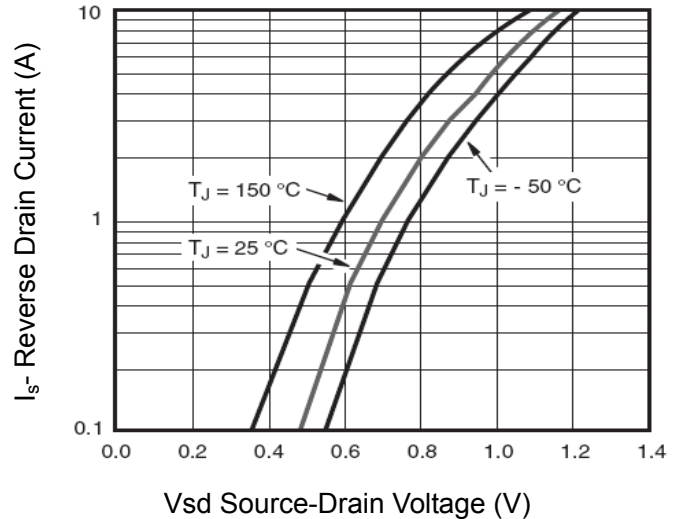
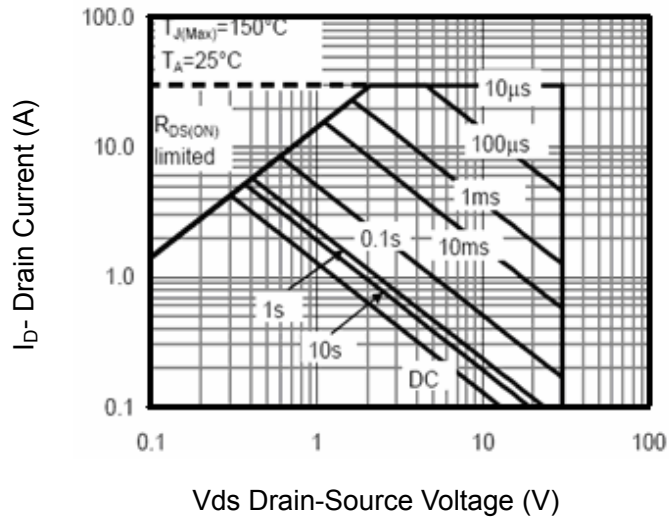


Figure 12 Source- Drain Diode Forward



Vds Drain-Source Voltage (V)
 Figure 13 Safe Operation Area

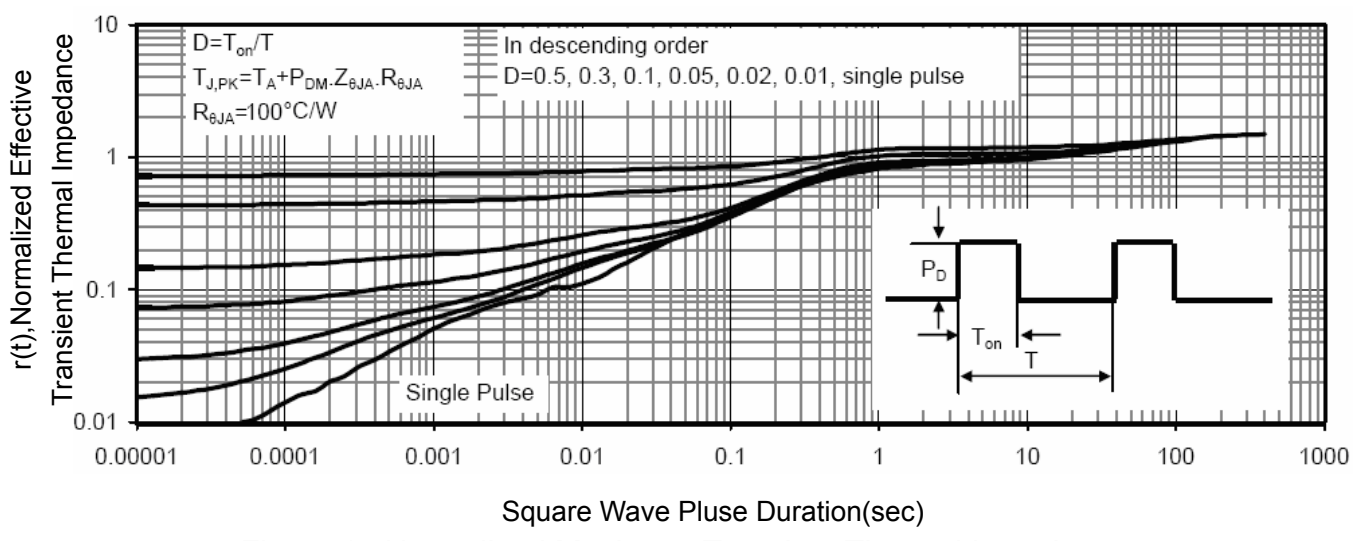
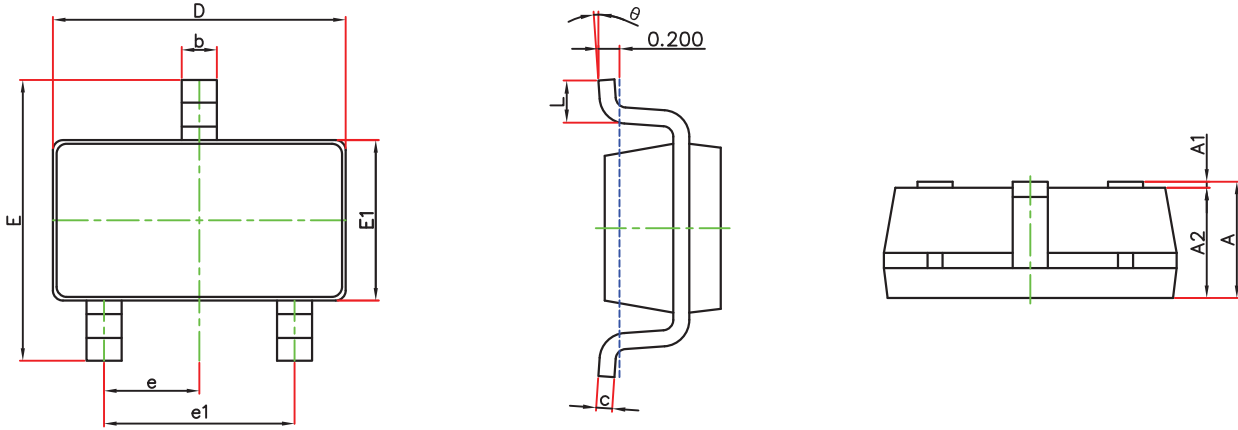


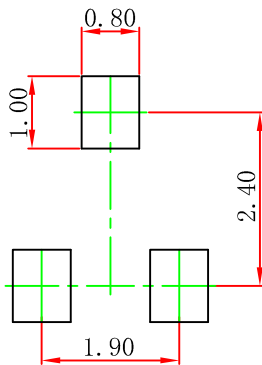
Figure 14 Normalized Maximum Transient Thermal Impedance

SOT-23-3L Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E1	1.500	1.700	0.059	0.067
E	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

SOT-23-3L Suggested Pad Layout



Note:

1. Controlling dimension: in millimeters.
2. General tolerance: $\pm 0.05\text{mm}$.
3. The pad layout is for reference purposes only.